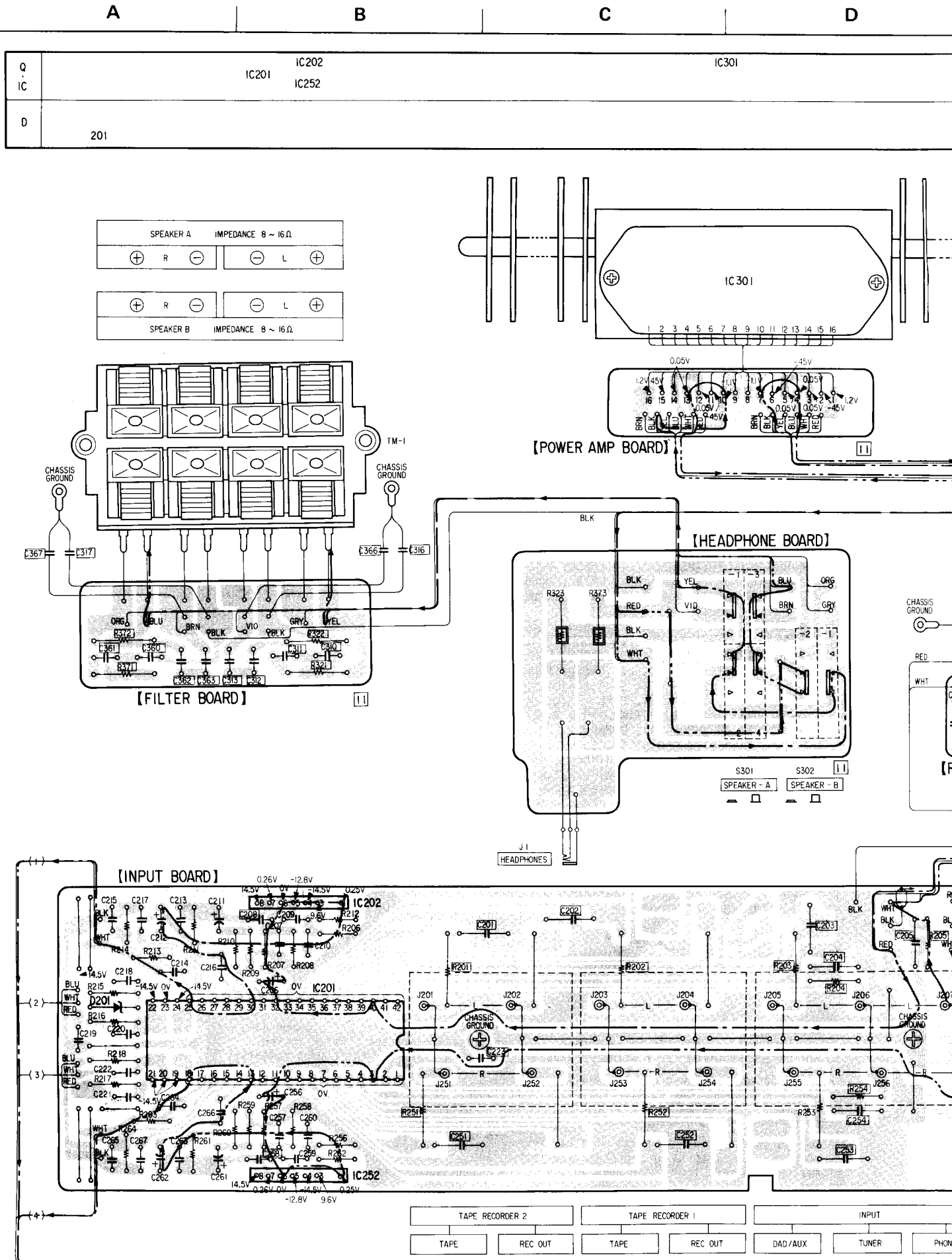


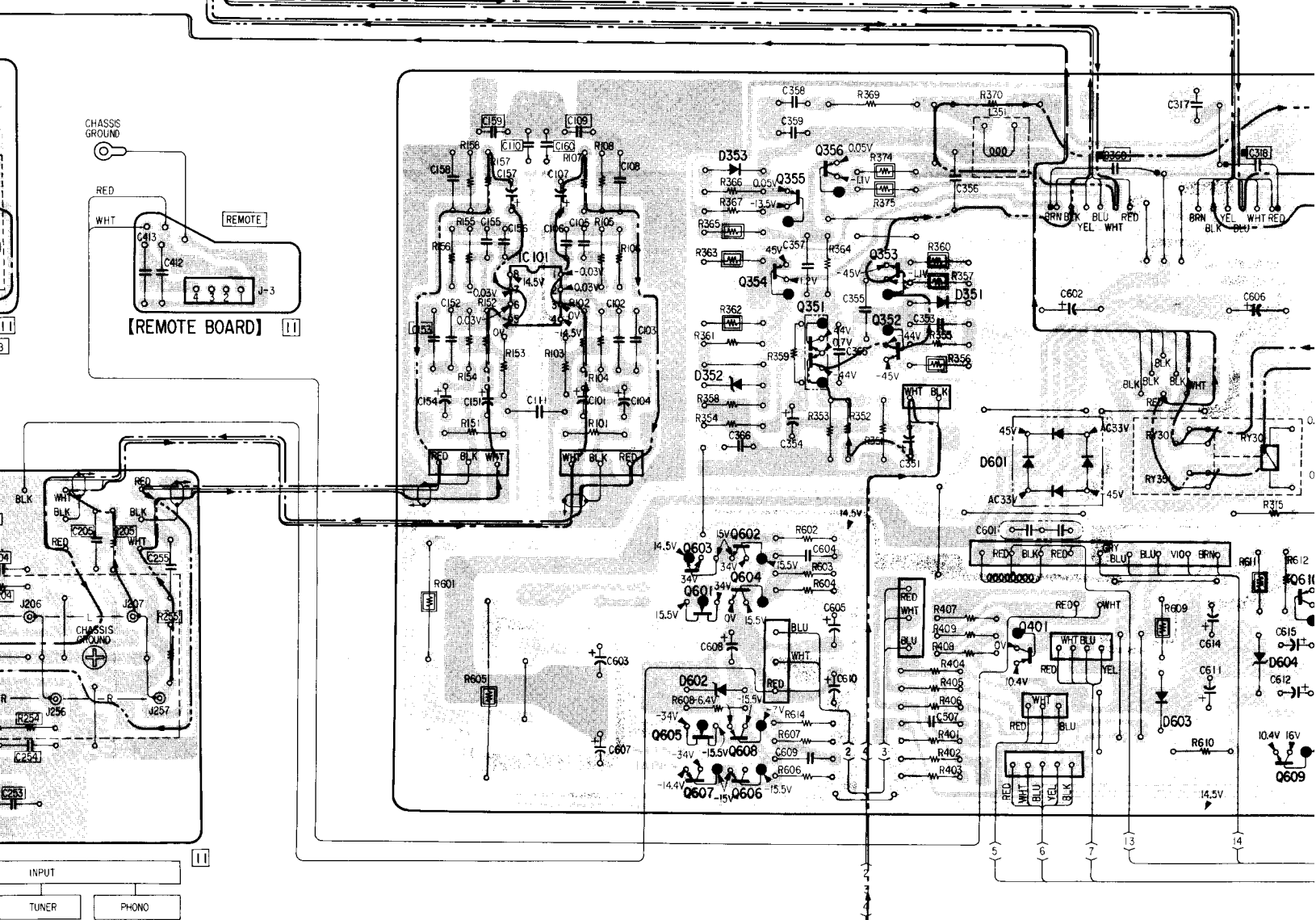
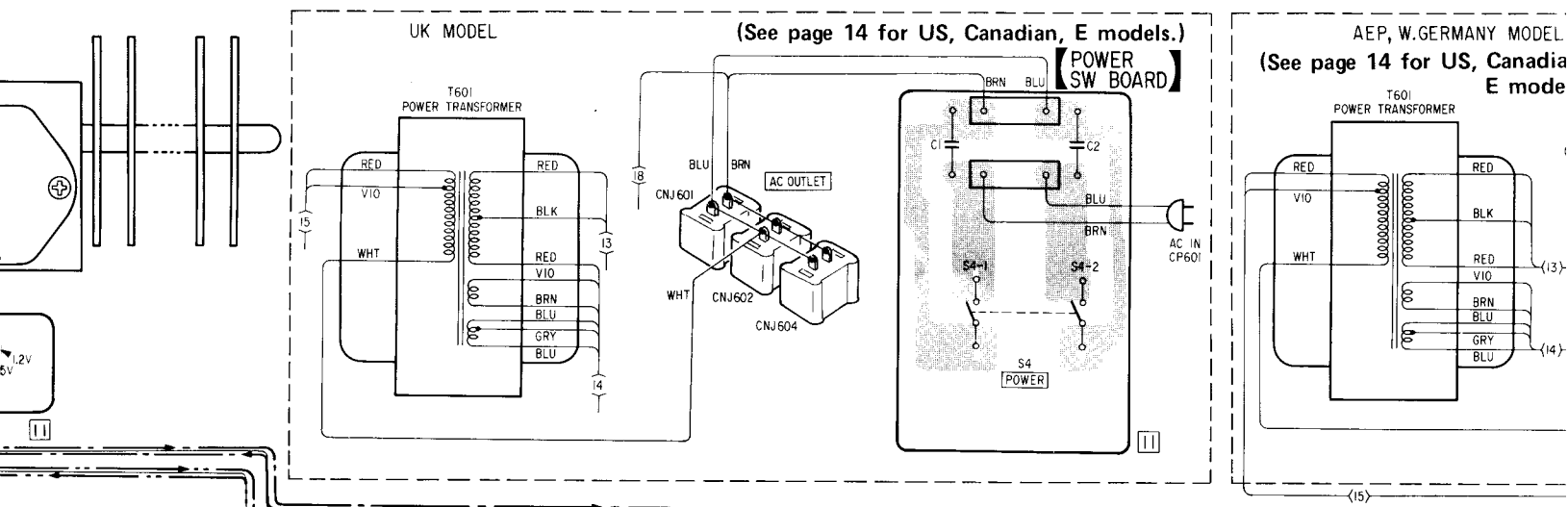
## 3-4. MOUNTING DIAGRAM

• See page 25 for semiconductor lead layouts.

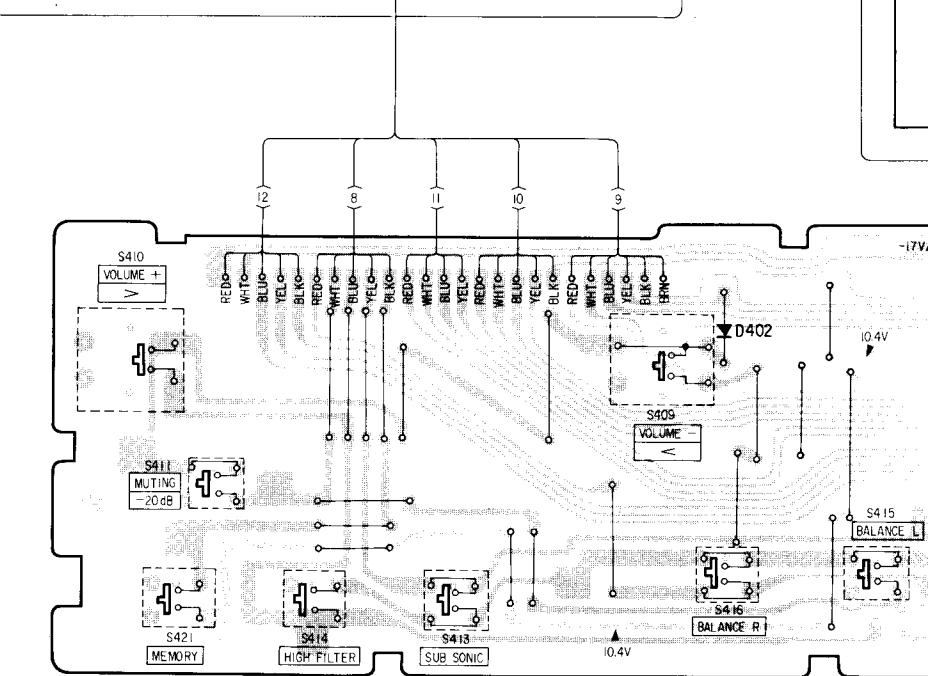
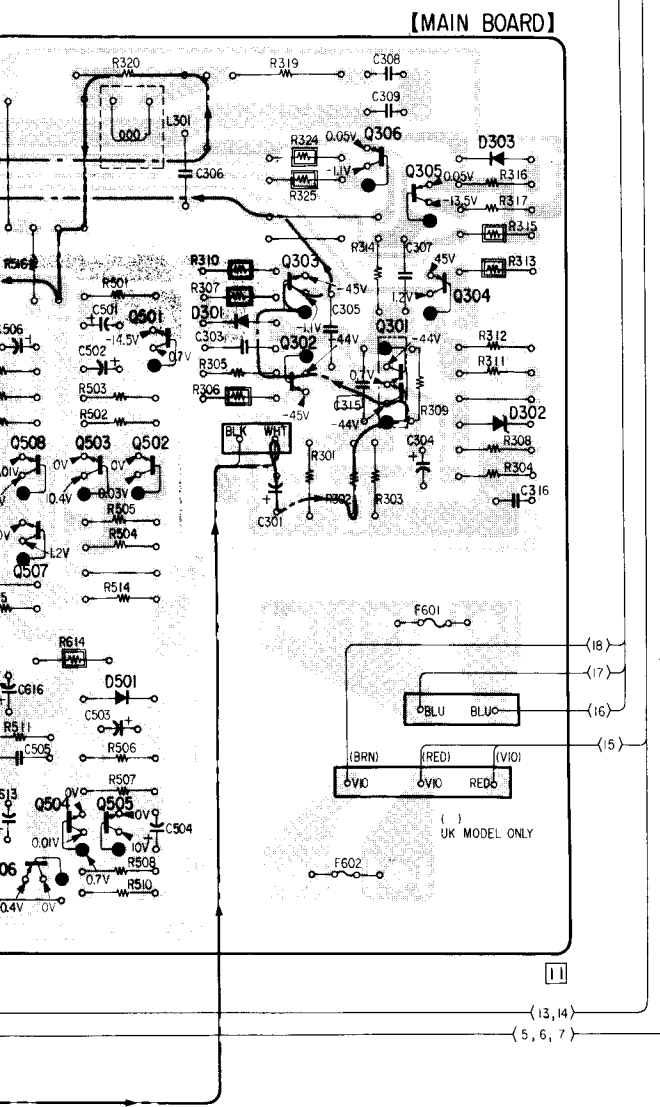
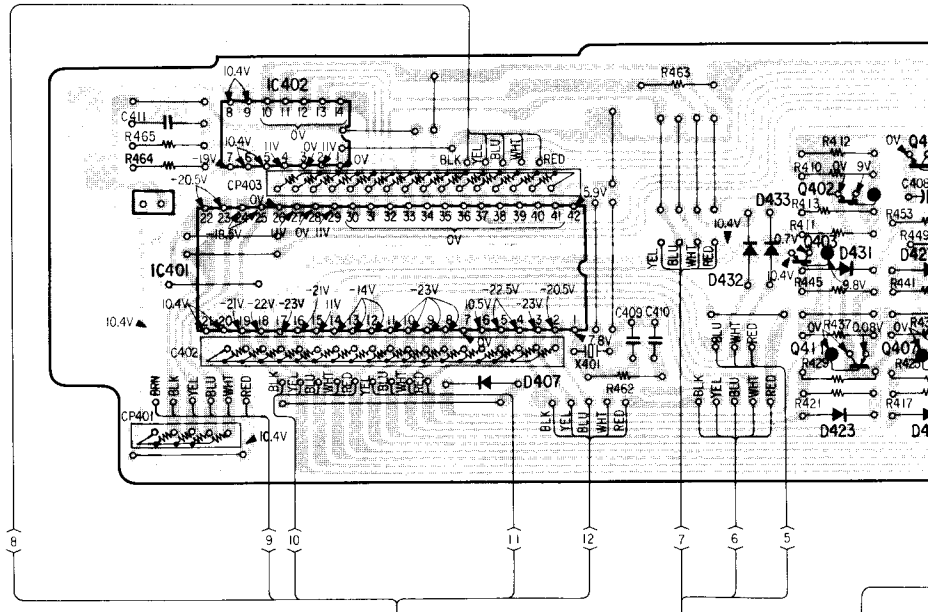
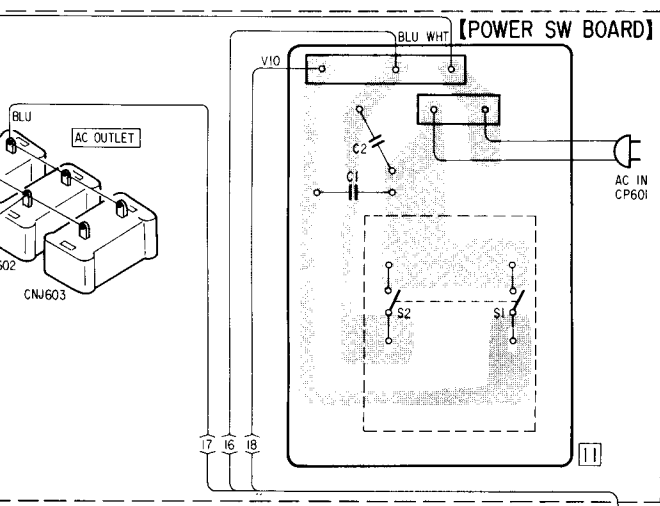


1C101      603 602      356  
 601 604      355 351      353  
 605 607 606 608      354      352      401      610

353  
 352  
 602      601      603      604



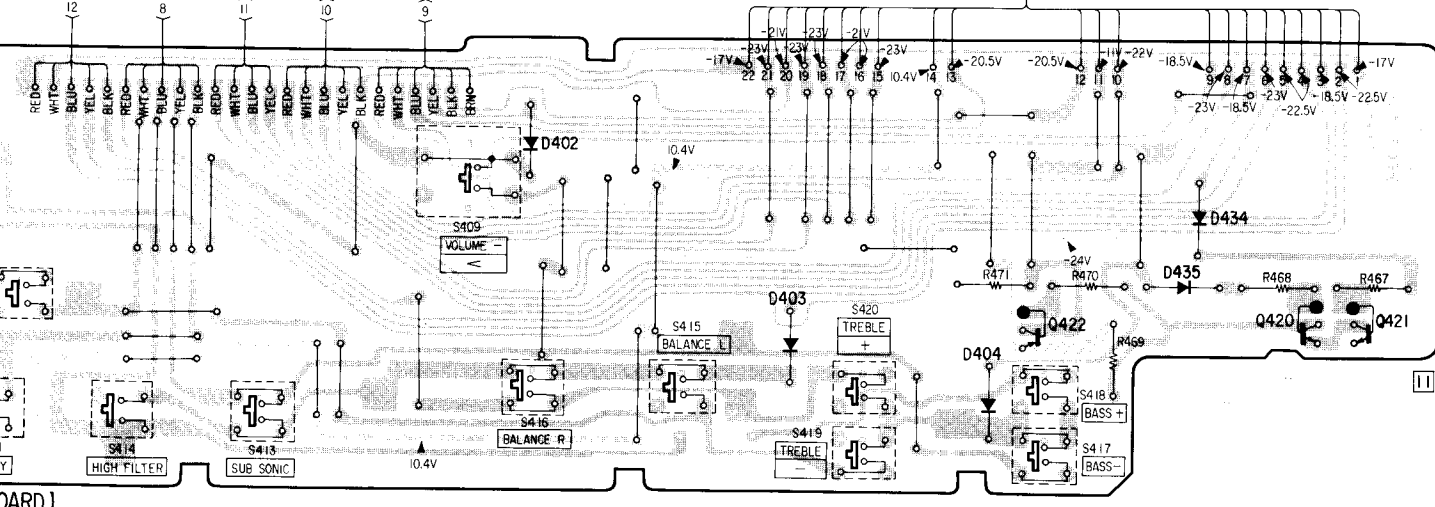
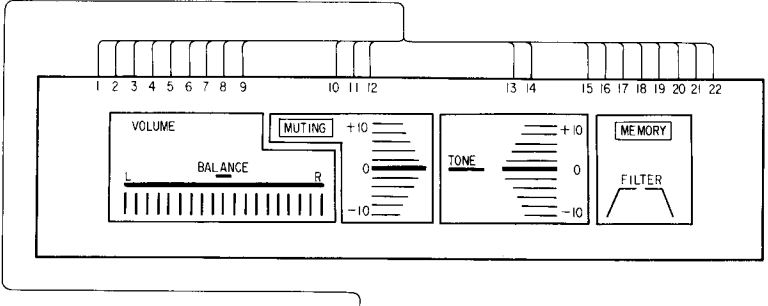
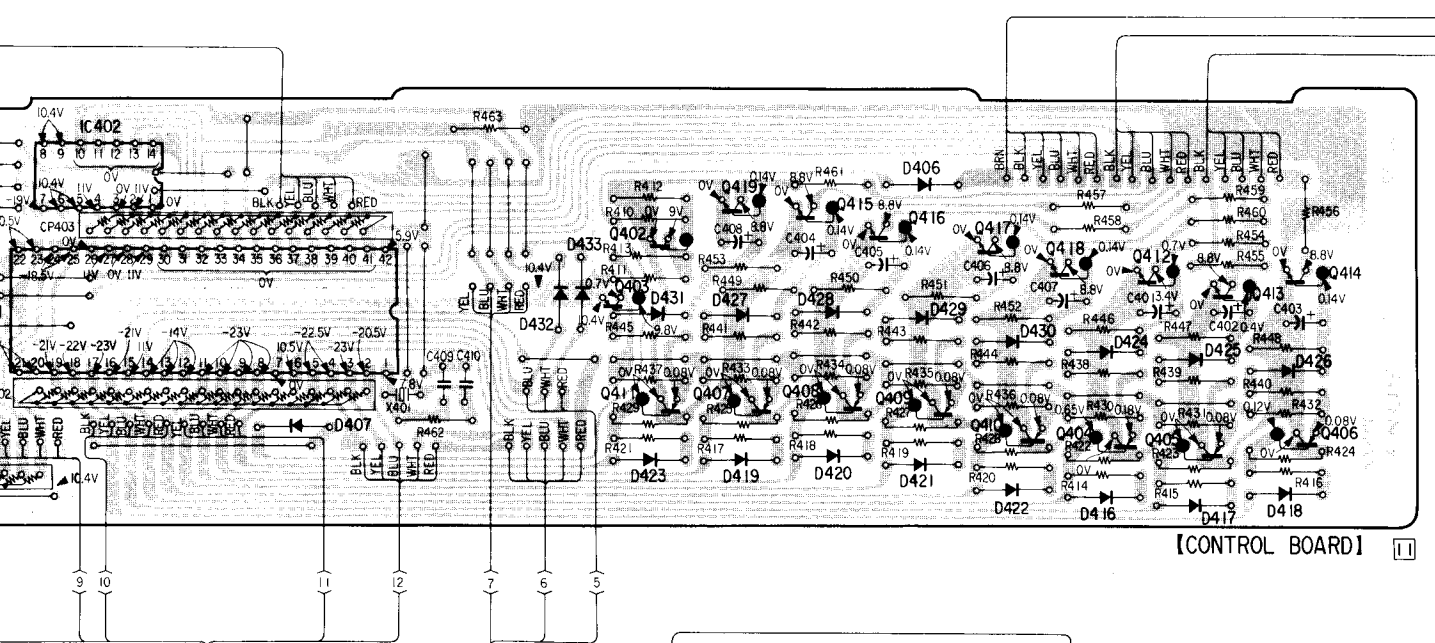
I	J	K	L
510 508 503 502 501 509 507 506 504 505	303 302 306 305 304 301	IC402 IC401	402 403 411 435 433 431 423 402
501	301 303 302	407	402



**TA-AX44 TA-AX44**

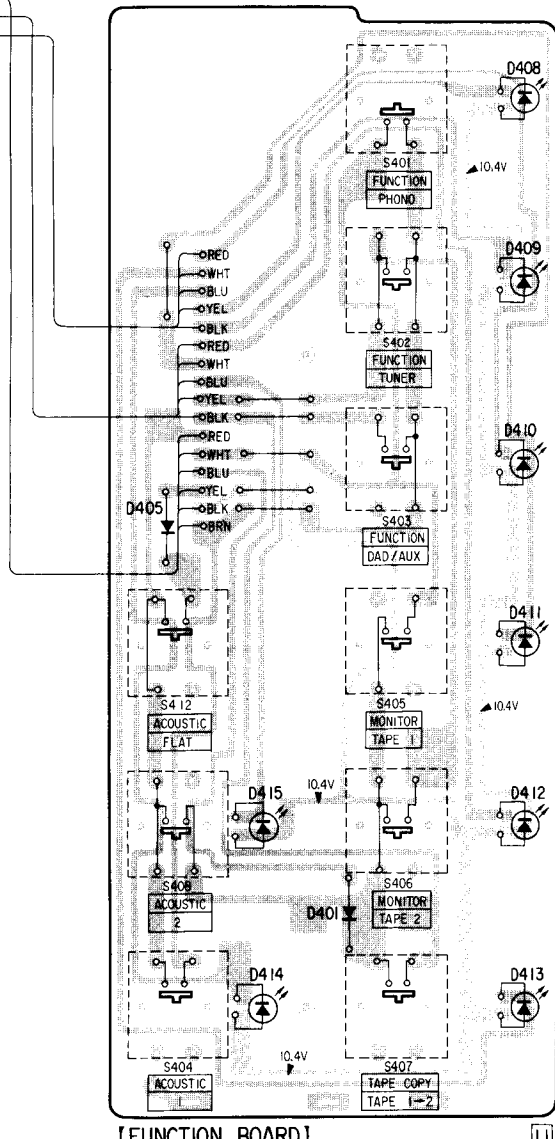
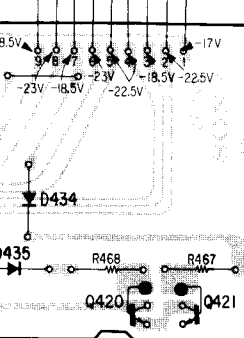
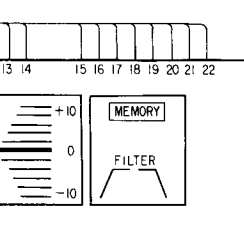
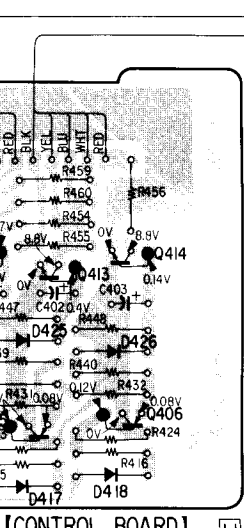
K L M N O

IC402	IC401		402	419	415	416	417	418	404	412	405	406		
			403	407	408	409	410							
									422				420	421
			407	435	433	431	427	428	406	429	430	424	425	426
				402		423	419	420	421		417	416	417	418
								403			404	435	434	



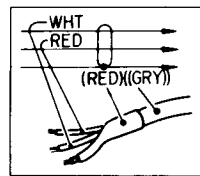
BOARD]

405	406	420	421	405	415	414	408	409	410	411	412	413	Q	IC
425	426												D	
417	418													
434														



**Note:**

• Color code of sleeving over the end of the jacket.



- — : parts extracted from the component side.
- — : parts extracted from the conductor side.
- : part mounted on the conductor side.
- : B + pattern

- —> : signal path
- —> : L-CH signal path
- —> : R-CH signal path
- : W. GERMANY MODEL

